

ABSTRACT OF THE DISCLOSURE

In this laminated ceramic capacitor, a heat radiation conductor is provided on a top face of a rectangular parallelepiped laminated chip where a plurality of first conductor layers and a plurality of second conductor layers are arranged alternatively through each ceramic layer with facing each other. In addition, the heat radiation conductor is connected to the upper edge of each second conductor layer. Therefore, when heat is generated in each first conductor layer and each second conductor layer which play the role of internal electrodes, the heat of each second conductor layer is directly transferred from each second conductor layer to the heat radiation conductor, and is radiated outside from the heat radiation conductor.